Graphene electronics

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Nanoelectronics FFF160

Outline

- Graphene production
 - Mechanical exfoliation
 - Epitaxial growth
 - Chemical vapor deposition
- Transport characteristics
- High frequency performance
- Inducing a band gap
 - Nanoribbon
 - Bilayer graphene
 - Chemical modification
- Performance comparison (graphene / CNTs)
- Other electronic CNT/graphene devices

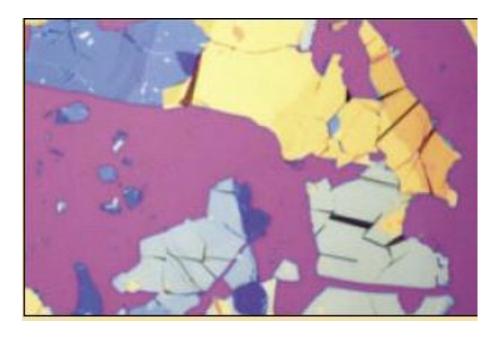
Outline

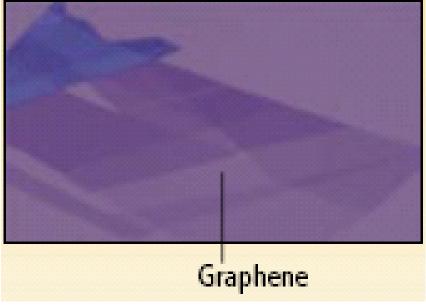
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Mechanical exfoliation

- Rub graphite on substrate
- Use adhesive tape to peel off layers
- 100x100 μm flakes -> mainly for research
- Visible in optical microscope

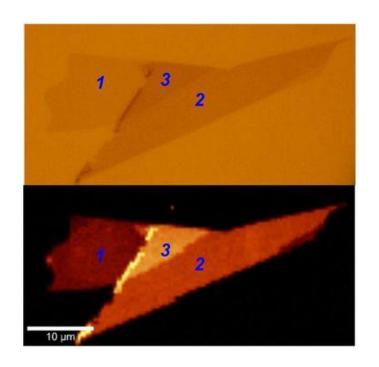


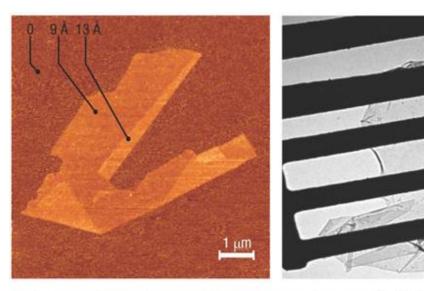


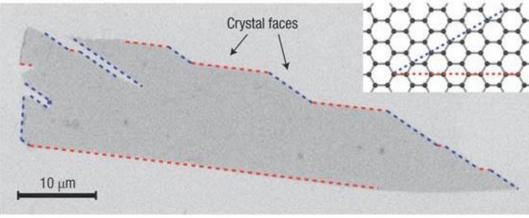


Observing graphene

- Optical microscope
- Atomic force microscopy
- TEM
- SEM
- Raman spectroscopy

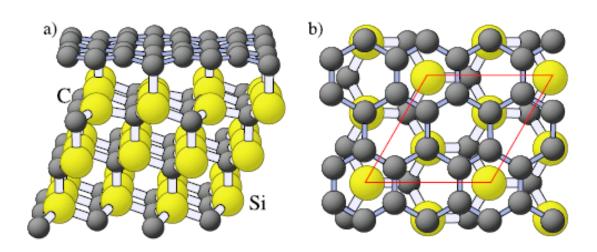


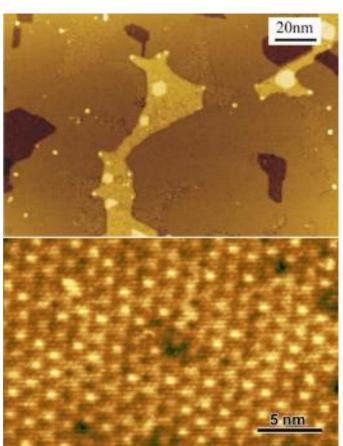




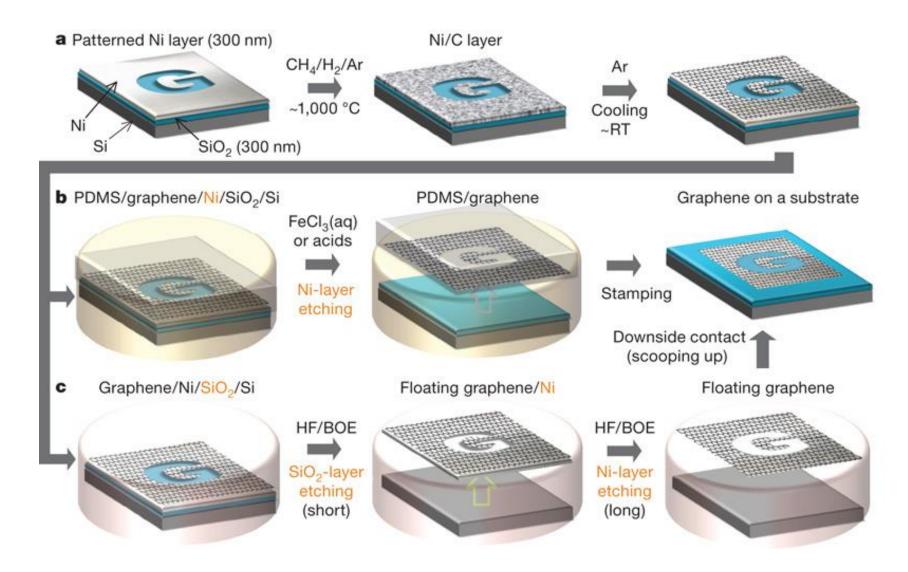
Epitaxial growth

- Prepare SiC surface by H₂ etching and heat to 1000°C by electron bombardment to remove native oxide
- Heat to 1250 °C to remove Si 1450 °C which will expose a graphene layer
- Often bi or trilayer graphene is formed



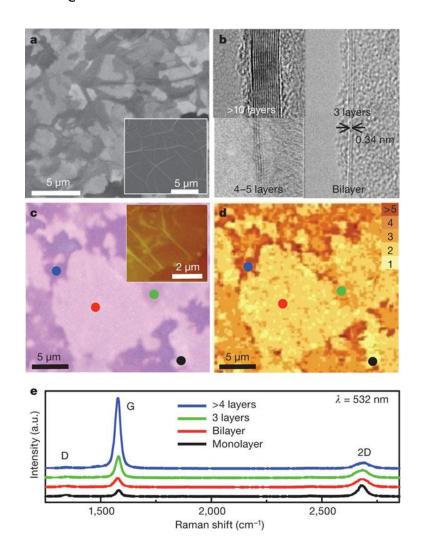


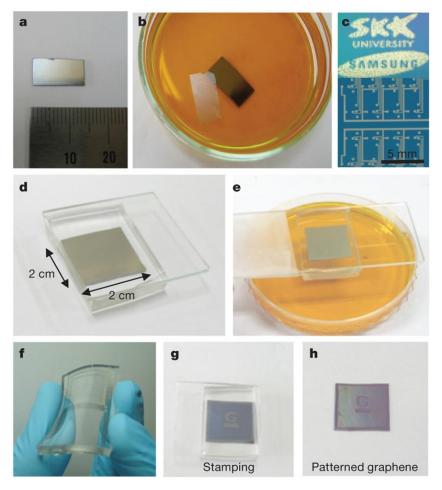
Chemical vapor deposition



Chemical vapor deposition - result

- Mix of single and multilayered
- μ_e =3,700 cm²/Vs after transfer





Large scale CVD production

Polymer support

Polymer support

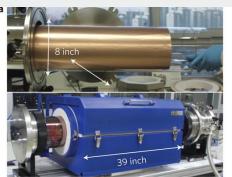
Released polymer support

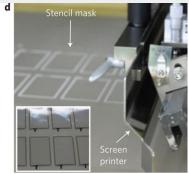
Graphene on Cu foil

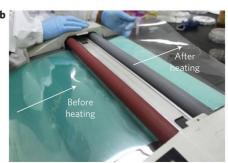
Cu etchant

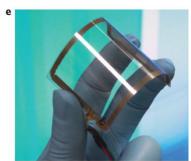
Graphene on target

- CVD on Cu foil
- 30 inch multilayer flake
- 30 Ω/□ at 90% transparency
- Better than ITO

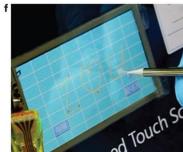












Outline

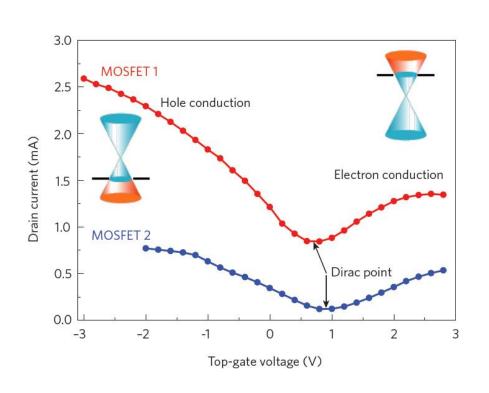
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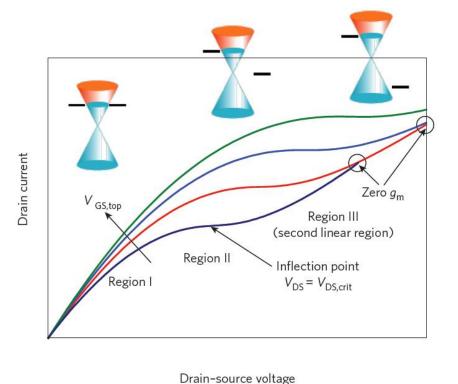
Graphene properties

- Thinnest material
- Largest surface area (3000 m² / gram)
- Strongest
- Stiffest
- Most stretchable (20%)
- Highest thermal conductivity
- Highest current density (1000 x Cu)
- Highest mobility (100 x Si)
- Longest mean free path (~ μm)

Transistor characteristics

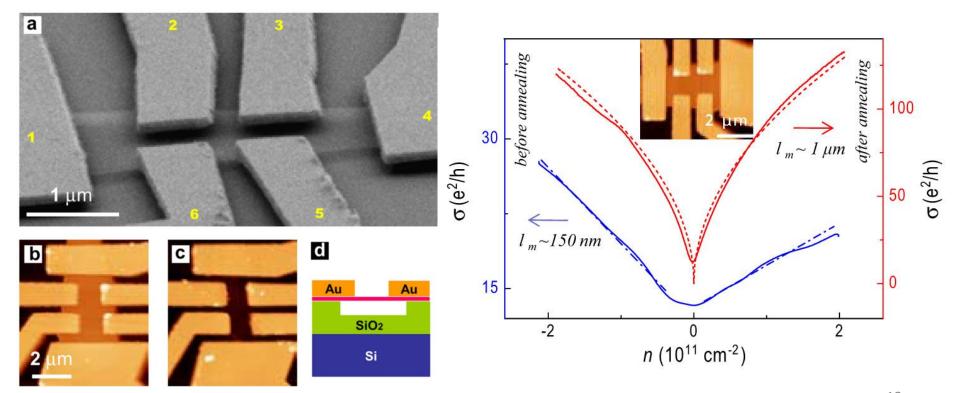
- No band gap -> poor on/off ratio
- Poor saturation
- Plateau at some gate voltages





Highest mobility

- Exfoliated graphene
- No band gap -> poor on/off ratio
- Unsuspended flakes: μ_e =2 000 30 000 cm²/Vs
- Supended and annealed flakes: μ_e =230 000 cm²/Vs
- Scattering due to impurities and edges

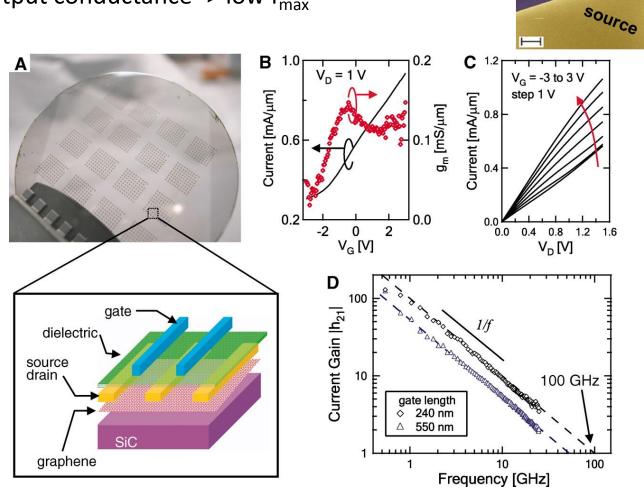


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High frequency device

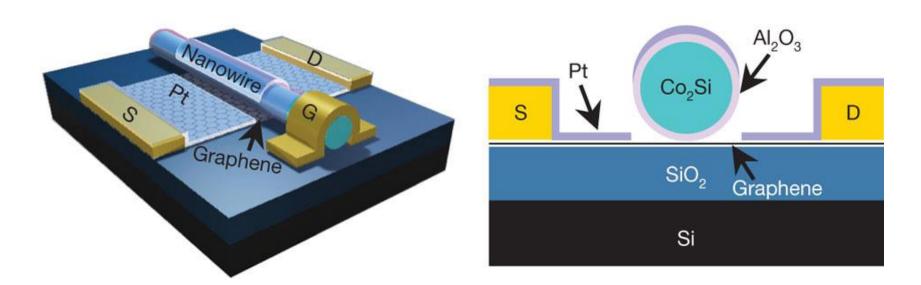
- SiC grown graphene
- $f_T=100 \text{ GHz for L}_g=240 \text{ nm}$
- Large output conductance -> low f_{max}



source

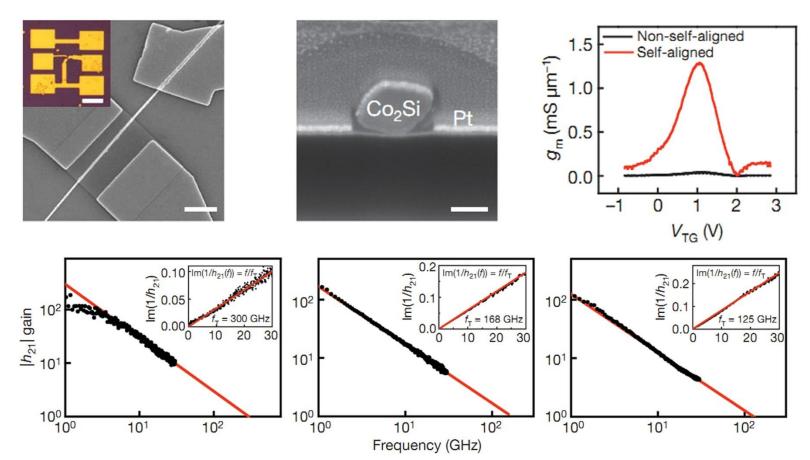
Graphene - nanowire device

- Mobility degrades when depositing dielectric
- Gate underlap: high source/drain access resistance reduce g_m
- Gate overlap: increased paracitic capacitances
- Deposit silicide nanowires with Al₂O₃ shell on exfoliated graphene
- Evaporate self-aligned Pt source/drain contacts



Graphene - nanowire device performance

- g_m improves after Pt
- f_T =300 GHz for L_g =144 nm
- Better than Si MOSFETs, similar to InP and GaAs HEMTs

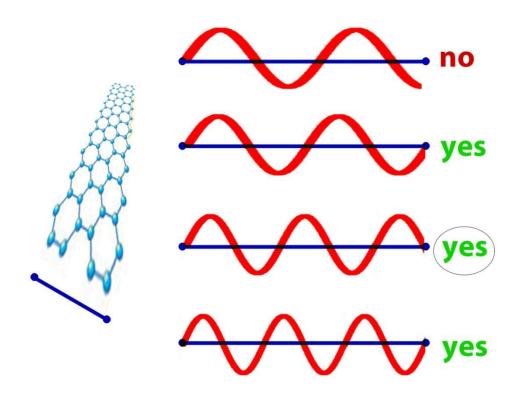


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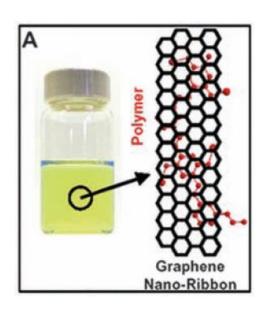
Confinement of electron wavefunctions

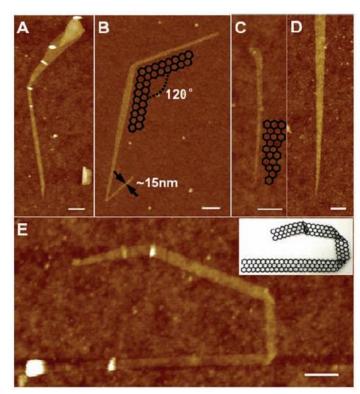
- Make narrow ribbon to introduce band gap
- Fixed boundary conditions instead of periodic (CNT)
- Wavevectors $k_1 = n\pi/C$ with n=1,2,3... allowed
- Need width = CNT circumference / 2 to get same band gap

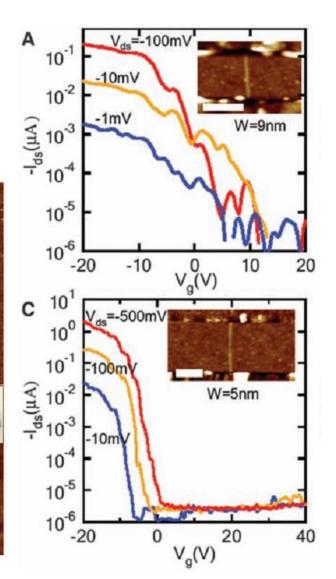


Chemical exfoliation

- Intercalate sulfuric acid and nitric acid in graphite
- Heat to 1000°C -> few-layered graphene sheets.
- Sonication with polymer -> graphene nanoribbons



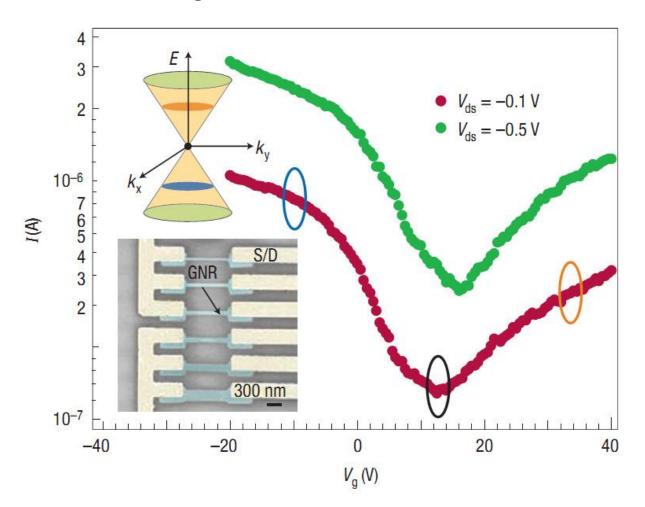




Li et al. *Science*, **319** (2008)

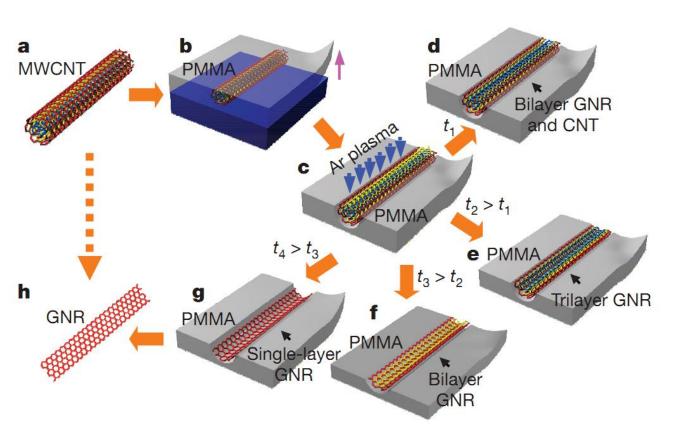
Etching

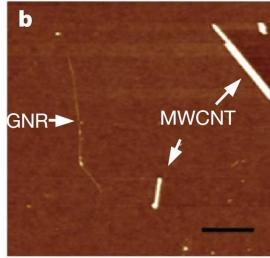
- Use e-beam lithography and oxygen plasma etching to etch flakes
- Not narrow enough
- Diffcult to control edges



Unzipping a CNT

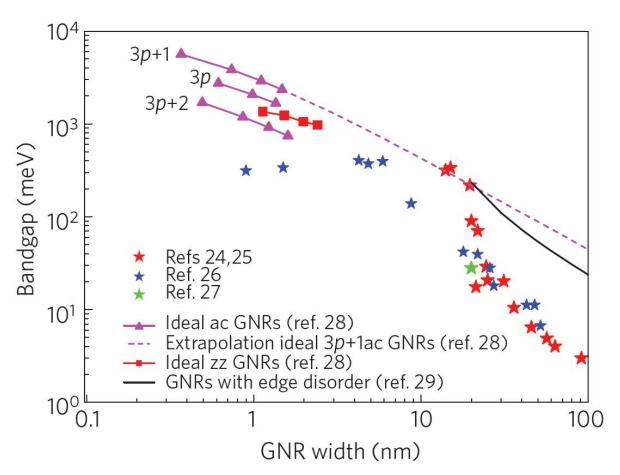
- Use oxygen plasma to remove layers of CNTs
- Very delicate process -> no mass production





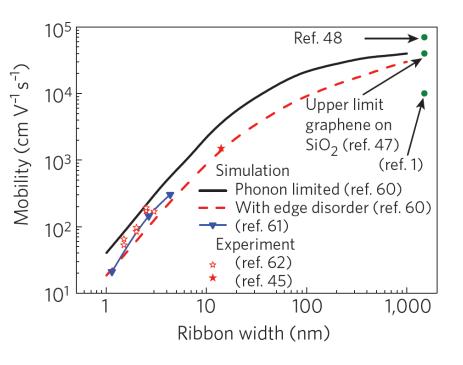
Band gap vs GNR width

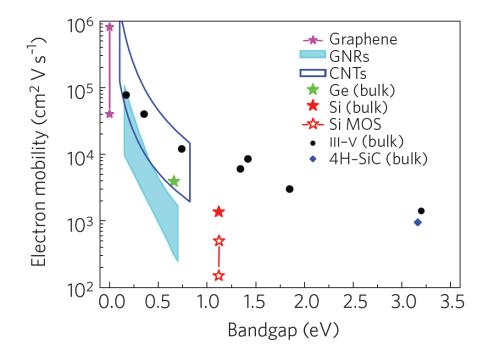
- Need 1 nm wide ribbons to get E_g=1 eV
- Gap depends on edge structure



Mobility degradation

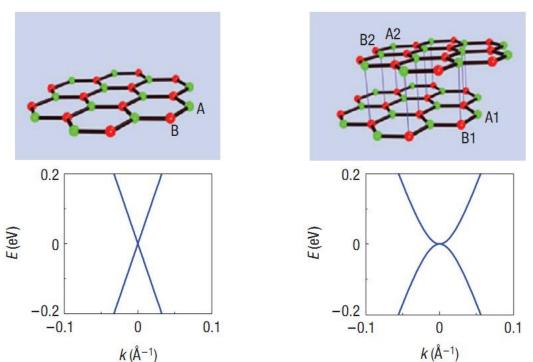
- Larger E_g -> higher m* -> lower mobility (as for CNTs)
- Graphene ribbons are worse than III-V materials

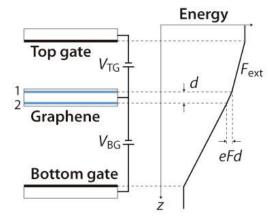


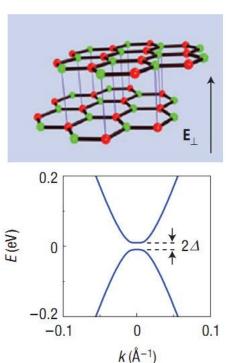


Bilayer graphene

- A perpendicular electric field breaks symmetry in bilayer graphene. Different energy for atoms in the two layers
- Band gap proportional to field opens



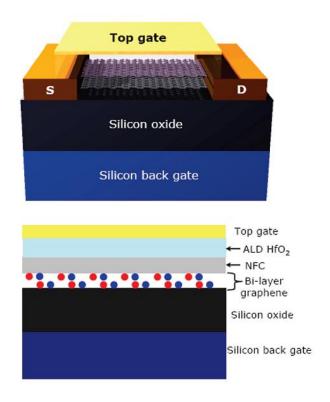


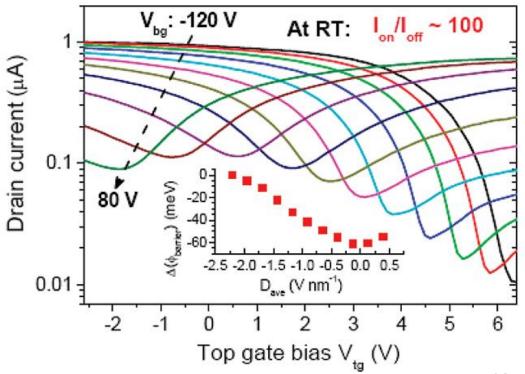


Oostinga et al. *Nature Mat.* **7**, 151 - 157 (2007)

Double gated bilayer device

- Need to apply 120 V to get on/off = 100
- Difficult to use for integrated circuits
- Mobility is probably degraded

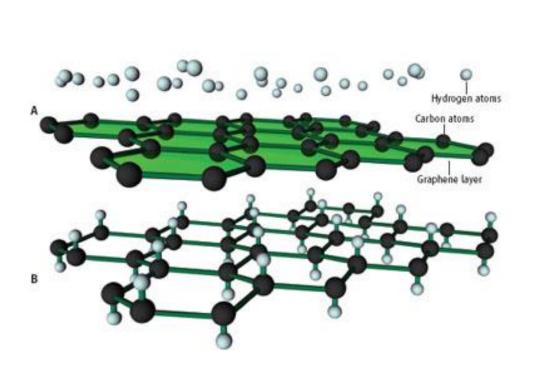


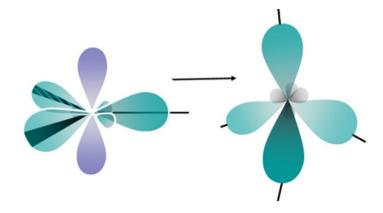


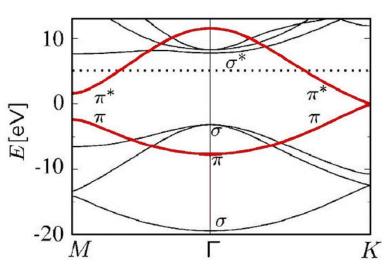
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Graphane

- Heat graphene in hydrogen -> graphane
- $sp^2 -> sp^3 -> remove conducting \pi-bonds and opening an energy gap$
- Lose the linear band dispersion of graphene







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Comparing CNT and graphene FETs

Graphene FETs	Carbon nanotubes FETs							
No band gap gives poor on/off ratio, not for logic only RF	Sufficient band gap for logic							
Difficult to control edges which gives mobility degradation	No dangling bonds							
Large area production possible	Need parallel CNTs to obtain high on-current and $g_{\rm m}$							
Only one type of device	No control of metallic / semiconducting type							

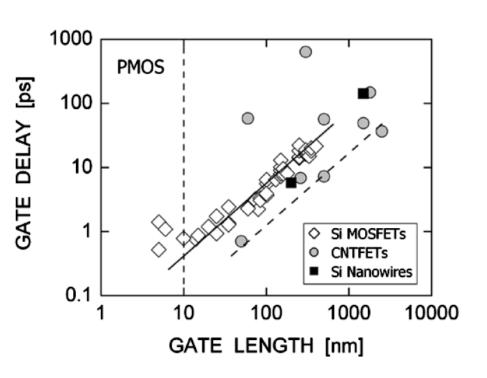
The future according to ITRS

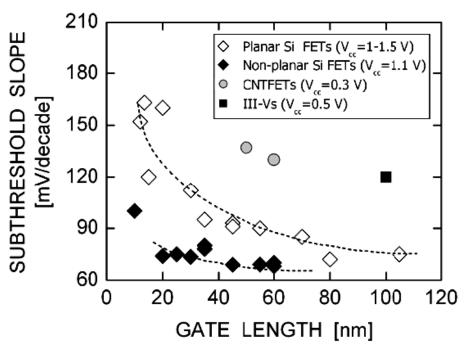
- The International Technology Roadmap for Semiconductors plans future development
- Mainly digital logic
- Keeps track of new devices and materials

First Year of IC Production	2009	2010	2011	2012	2013	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023 2024	
Chirality of CNTs																
Semiconducting vs metallic									Research Required							
n/p Doping Control																
Diameter of CNTs									Development Underway Qualification / Pre-Production							
Direction of CNS Samur																
Wall thickness - Single wall									Continu							
Graphene Epitaxy																
Edge Control of Graphene																
Bandgap Control of Graphene																
Ohmic contacts																
Hi-K Gate dielectric & gate metal																

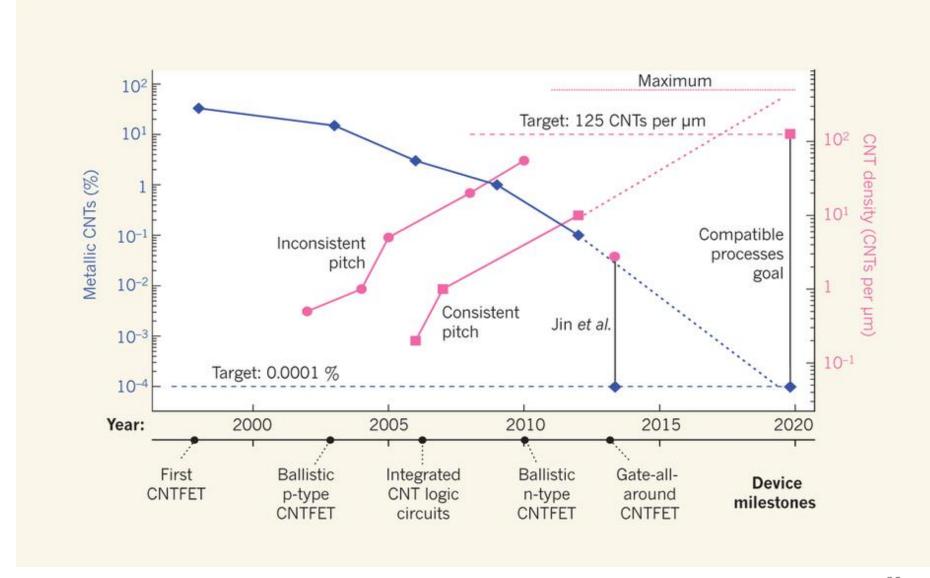
Benchmark comparisons

- From DC measurements: gate delay, energy delay product, subthreshold slope
- Large spread in results for CNTs
- Gate delay (CV/I) may be quite incorrect

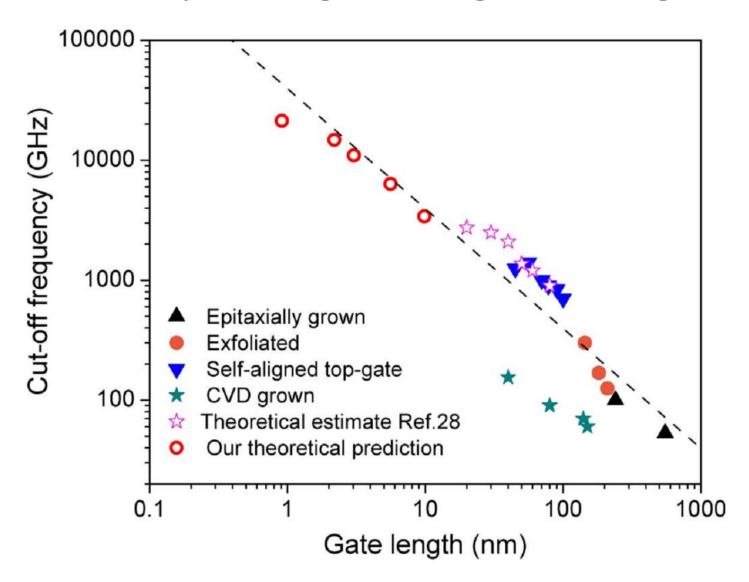




CNT density and purity

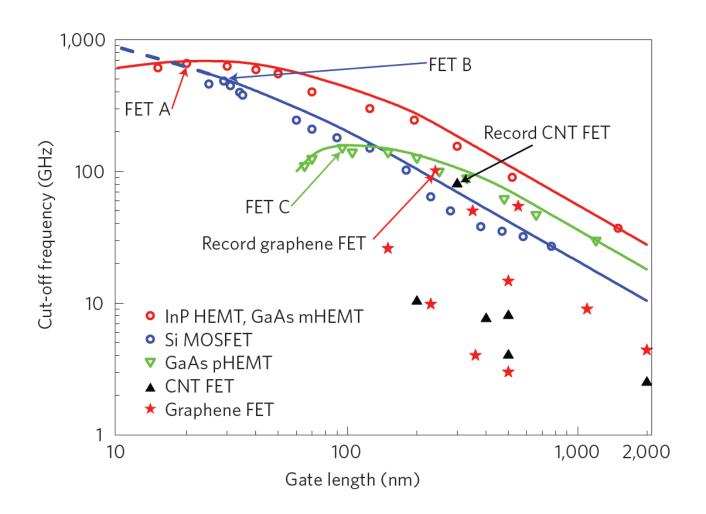


Graphene gate length scaling



Comparing high frequency performance

- III-V materials are still better
- Need to reduce L_g of CNT/graphene FET



Why carbon electronics?

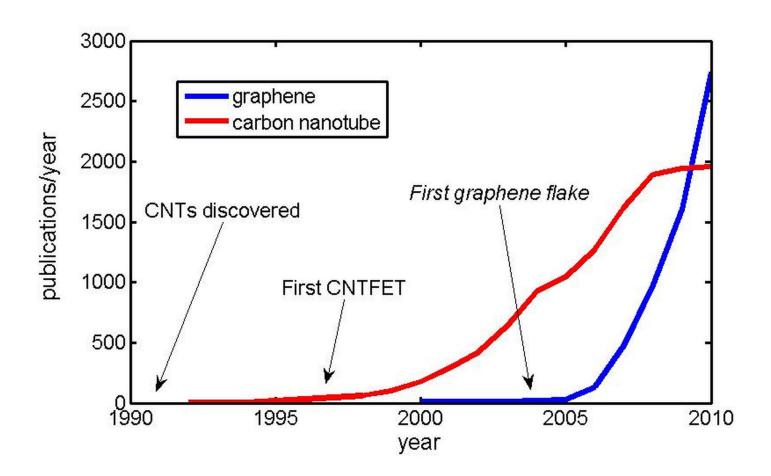
- + High mobility
- + High carrier velocity
- + High current density
- + Good electrostatics
- + Compatible with high-k dielectrics
- + Same electron/hole band structure

Why not?

- Uncontrolled band gap
- Poor position control
- Unstable doping
- Difficult to mass produce

Very active research

- Rapidly increasing # of publications
- Graphene > CNTs in 2009



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Not only transistors

- supercapacitor electrodes
- memories
- LEDs
- photodiodes
- solar cells
- interconnects
- transparent electrodes
- NEMS for mass sensing
- DNA sequencing
- quantum computing
- spintronics

